

**• General Description**

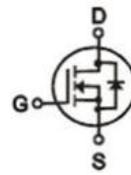
The ZM045N03N combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

**• Features**

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

**• Application**

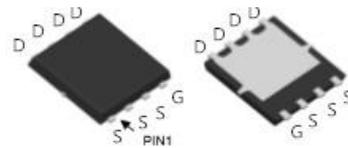
- MB/VGA Vcore
- Synchronous Rectifier
- BLDC Motor driver

**• Product Summary**


$V_{DS} = 30V$

$R_{DS(ON)} = 4.5m\Omega$

$I_D = 75A$


**DFN5 x 6**
**• Ordering Information:**

Part NO.	ZM045N03N
Marking	ZM045N03
Packing Information	REEL TAPE
Basic ordering unit (pcs)	3000

**• Absolute Maximum Ratings ( $T_C = 25^\circ C$ )**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D @ T_C = 25^\circ C$	75	A
	$I_D @ T_C = 75^\circ C$	57	A
	$I_D @ T_C = 100^\circ C$	47	A
Pulsed Drain Current <sup>①</sup>	$I_{DM}$	180	A
Total Power Dissipation	$P_D @ T_C = 25^\circ C$	80	W
Total Power Dissipation	$P_D @ T_A = 25^\circ C$	2.5	W
Operating Junction Temperature	$T_J$	-55 to 150	$^\circ C$
Storage Temperature	$T_{STG}$	-55 to 150	$^\circ C$
Single Pulse Avalanche Energy	$E_{AS}$	100	mJ

**•Thermal resistance**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	$R_{thJC}$	-	-	1.6	°C/W
Thermal resistance, junction - ambient	$R_{thJA}$	-	-	50	°C/W
Soldering temperature, wavesoldering for 10s	$T_{sold}$	-	-	265	°C

**•Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = 250\mu A$	1.2		2.5	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS} = 30V, V_{GS} = 0V$			1.0	$\mu A$
Gate- Source Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$			$\pm 100$	nA
Static Drain-source On Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 20A$		4.5	5.6	m $\Omega$
		$V_{GS} = 4.5V, I_D = 10A$		7.0	9.0	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 10V, I_D = 10A$		7		S
Source-drain voltage	$V_{SD}$	$I_S = 20A$		0.8	1.28	V

**•Dynamic Characteristics**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	$C_{iss}$	$f = 1MHz$	-	1500	-	pF
Output capacitance	$C_{oss}$		-	280	-	
Reverse transfer capacitance	$C_{rss}$		-	140	-	
Total gate charge	$Q_g$	$V_{DD} = 25V$	-	31	-	nC
Gate - Source charge	$Q_{gs}$	$I_D = 8A$	-	4.3	-	
Gate - Drain charge	$Q_{gd}$	$V_{GS} = 10V$	-	8.7	-	
Turn-ON Delay time	$t_{D(on)}$	$V_{GS} = 10V, V_{DS} = 15V$ $R_G = 3.3\Omega, I_D = 15A$		7.5		ns
Turn-ON Rise time	$t_r$			14		ns
Turn-Off Delay time	$t_{D(off)}$			35		ns
Turn-Off Fall time	$t_f$			10		ns
Reverse Recovery Time	$T_{rr}$		$I_{sd} = 20A, V_{GS} = 0V$		19	
Reverse Recovery Charge	$Q_{rr}$	$di/dt = 100A/\mu s$		5.4		nC

Note: ① Pulse Test : Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$  ;

Fig.1 Power Dissipation

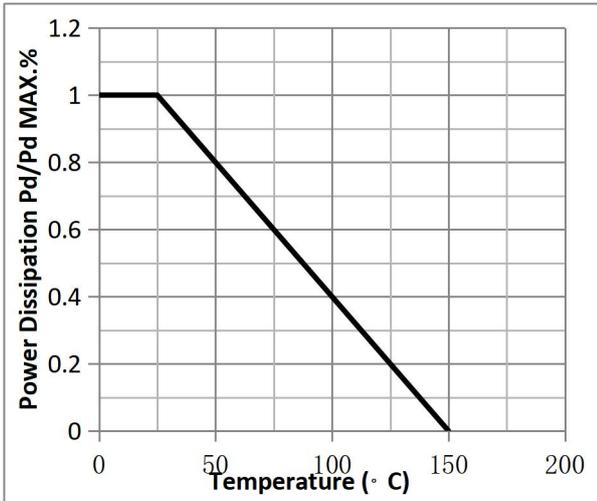


Fig.2 Typical output Characteristics

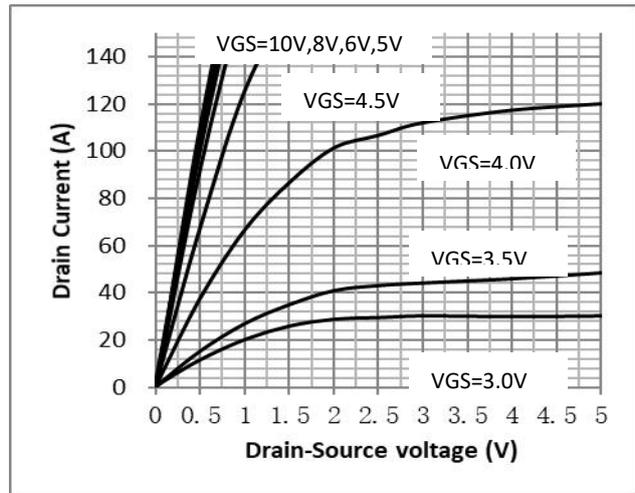


Fig.3 Threshold Voltage V.S Junction Temperature

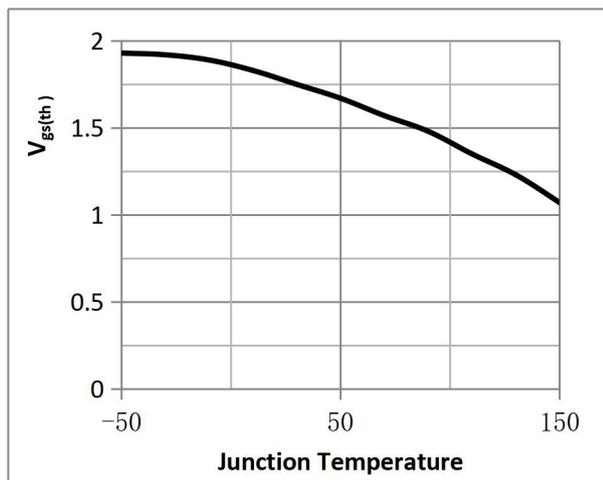


Fig.4 Resistance V.S Drain Current

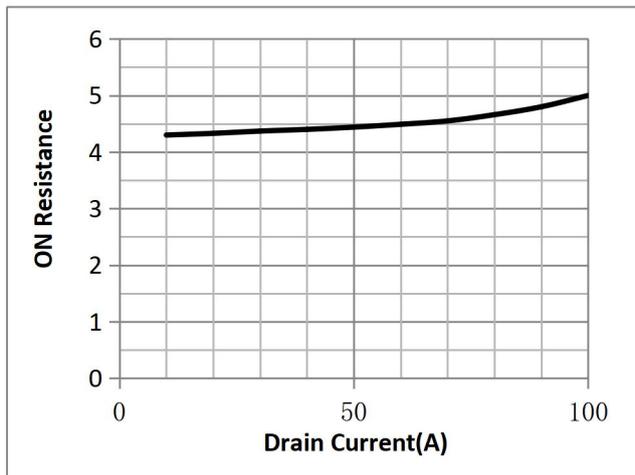


Fig.5 On-Resistance VS Gate Source Voltage

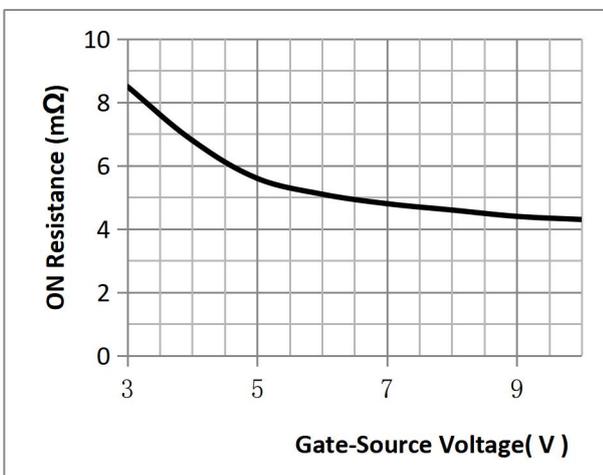


Fig.6 On-Resistance V.S Junction Temperature

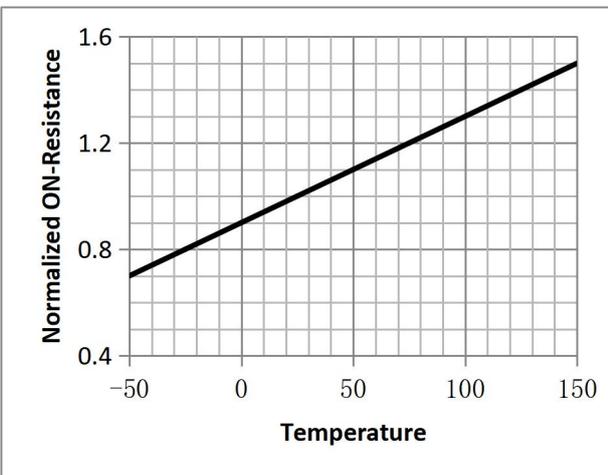


Figure 7. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

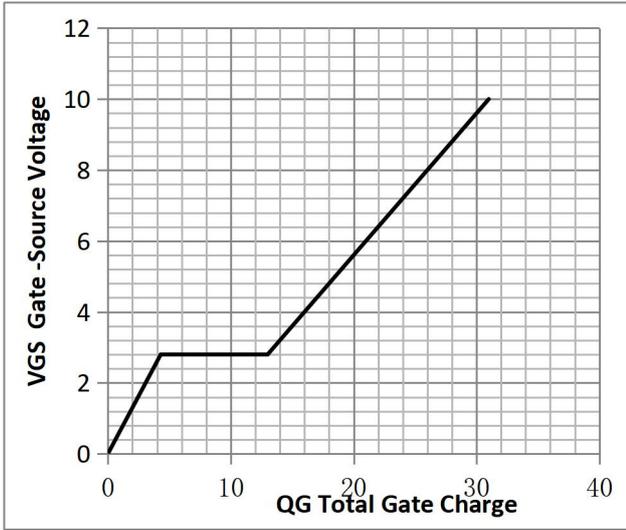


Fig.8 Capacitance Variation

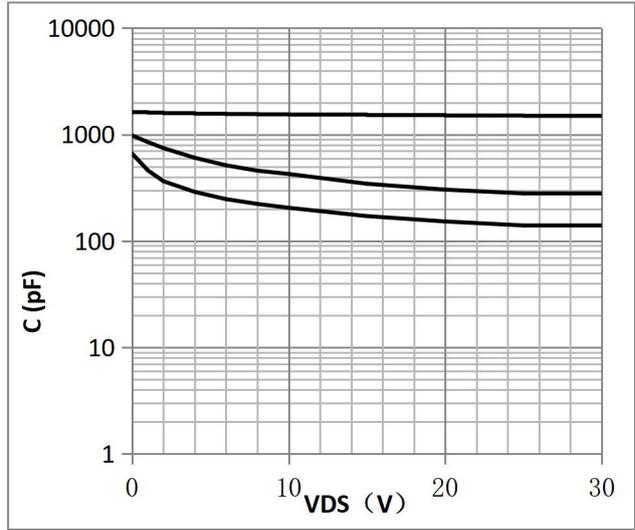


Figure 9. Diode Forward Voltage vs. Current

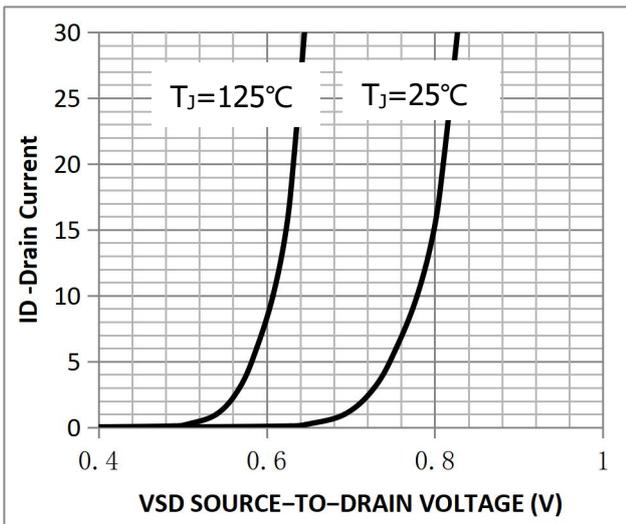


Figure 10. Transfer Characteristics

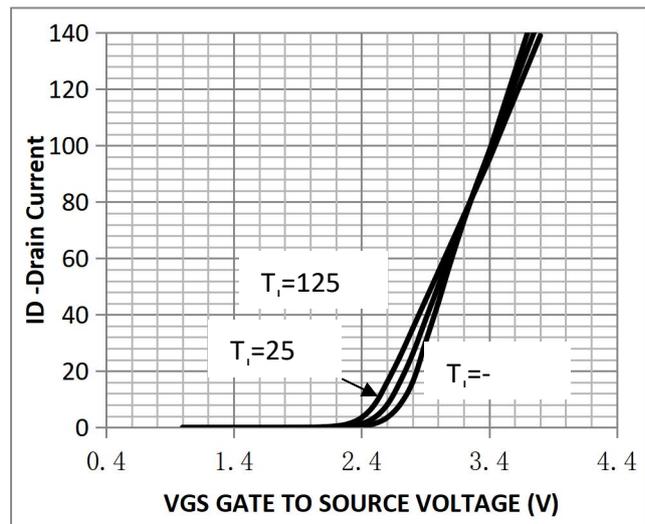


Fig.11 SOA Maximum Safe Operating Area

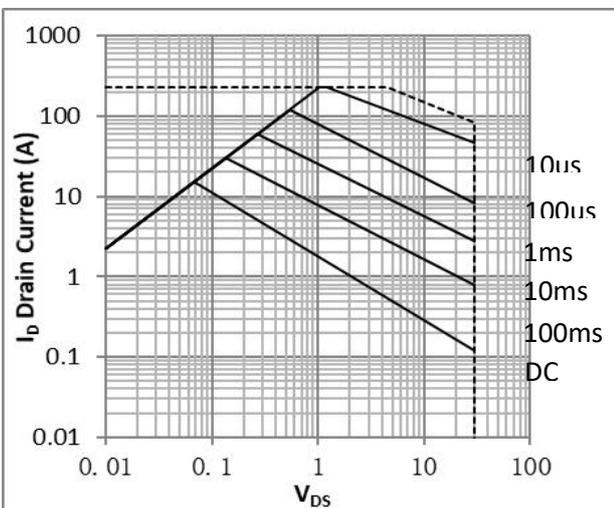


Fig.12 ID-Junction Temperature

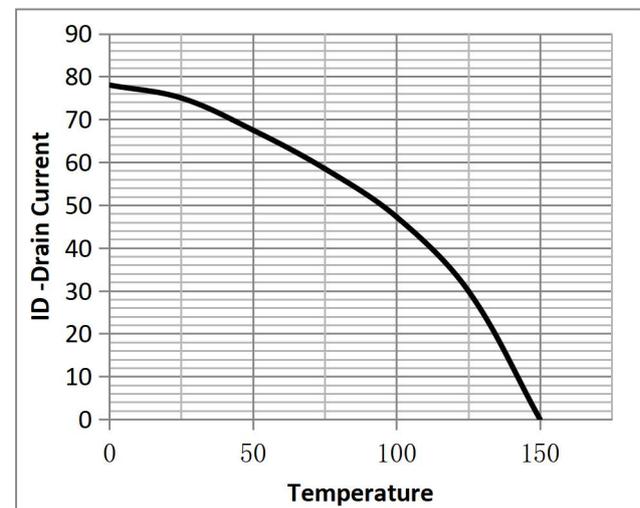


Fig.13 Switching Time Measurement Circuit

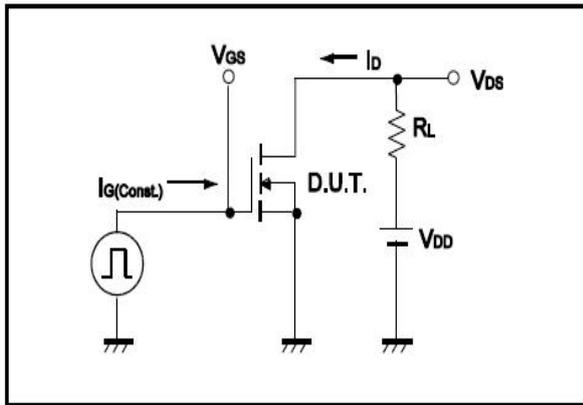


Fig.14 Gate Charge Waveform

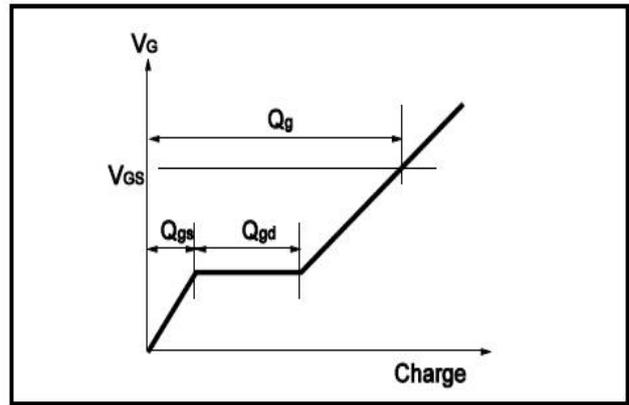


Fig.15 Switching Time Measurement Circuit

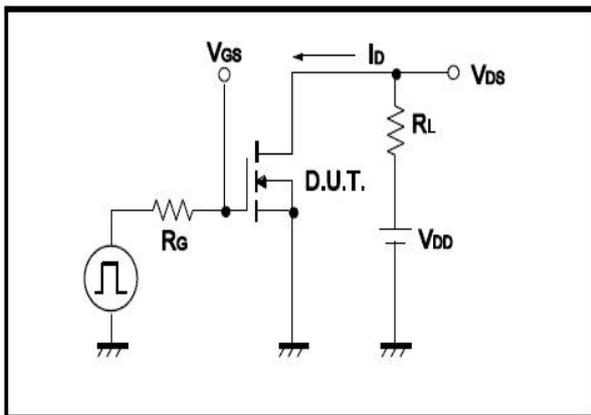


Fig.16 Gate Charge Waveform

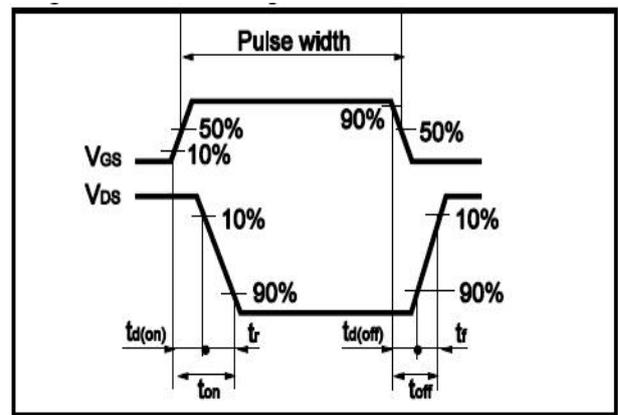


Fig.17 Avalanche Measurement Circuit

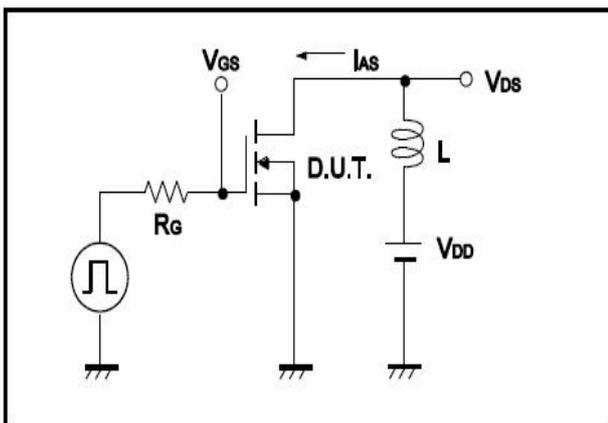
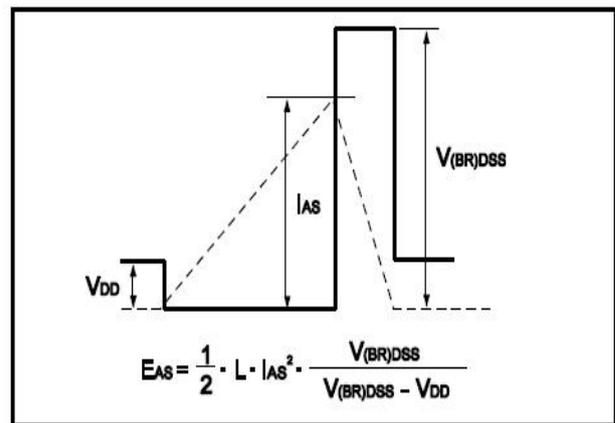


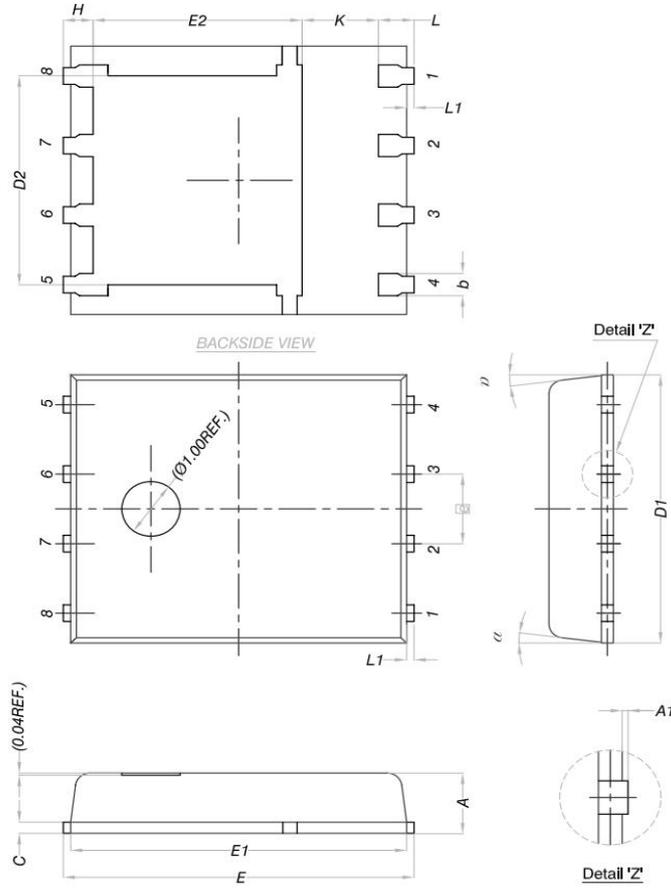
Fig.18 Avalanche Waveform





•Dimensions (DFN5×6)

Unit: mm



DIM.	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
A1	0	-	0.05
b	0.33	0.41	0.51
C	0.20	0.25	0.30
D1	4.80	4.90	5.00
D2	3.61	3.81	3.96
E	5.90	6.00	6.10
E1	5.70	5.75	5.80
E2	3.38	3.58	3.78
e	1.27 BSC		
H	0.41	0.51	0.61
K	1.10	-	-
L	0.51	0.61	0.71
L1	0.06	0.13	0.20
α	0°	-	12°



Version	Date	Change
A	2017.1.6	
B	2021.6.26	1.Add Dynamic characteristic $t_f$ , $t_r$ etc.
C	2023.6.5	1.Add Reach, HF figure, 2.ID modify
D	2024.8.30	Modified $R_{dson}$ up limit